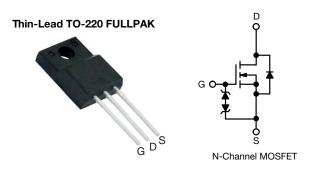
SiHA11N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.391				
Q _g max. (nC)	42				
Q _{gs} (nC)	6				
Q _{gd} (nC)	12				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA11N80AE-GE3				

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	v	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T ₁ = 150 °C) ^e	V _{GS} at 10 V	$_{S}$ at 10 V $\frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		8		
Continuous drain current $(I_J = 150^{-1}C)^{\circ}$	VGS at TO V	T _C = 100 °C	I _D	5	А	
Pulsed drain current ^a			I _{DM}	22	1	
Linear derating factor				0.25	W/°C	
Single pulse avalanche energy ^b			E _{AS}	88	mJ	
Maximum power dissipation			PD	31	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	70	V/ns		
Reverse diode dv/dt ^d			2	v/ns		
Soldering recommendations (peak temperature) ^c For 10 s			260	°C		
Mounting torque, M3 screw				0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.5 A

c. 1.6 mm from case

d. $I_{SD} \le I_D$, di/dt = 100 A/µs, starting T_J = 25 °C e. Limited by maximum junction temperature

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	- 65			°C/W			
Maximum junction-to-case (drain)	R _{thJC}	- 4						
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{GS}, I_D = 2$	250 µA	2	-	4	V
Onto norman lankana		$V_{GS} = \pm 20 \text{ V}$		-	-	± 10		
Gate-source leakage	I _{GSS}	\ \	V _{GS} = ± 30 V		-	-	± 50	μA
	1	V _{DS} =	800 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	, V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 5.5 A	-	0.391	0.450	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 30 V, I _D =	= 5.5 A	-	2.9	-	S
Dynamic								
Input capacitance	C _{iss}		V _{GS} = 0 V, V _{DS} = 100 V,		-	804	-	-
Output capacitance	C _{oss}	``			-	34	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	pF	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	27	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	162	-		
Total gate charge	Qg				-	28	42	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 5.5 A, V _{DS} = 640 V		-	6	-	nC
Gate-drain charge	Q _{gd}				-	12	-	
Turn-on delay time	t _{d(on)}				-	13	26	
Rise time	t _r	V _{DD} =	640 V, I _D =	= 5.5 A,	-	15	30	
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	25	50	ns	
Fall time	t _f			-	27	54		
Gate input resistance	R _g	f = 1 MHz, open drain		0.7	1.5	3	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8		
Pulsed diode forward current	I _{SM}			-	-	22	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	, I _S = 5.5 A	A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	278	556	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 5.5 \text{ A},$		-	2.9	5.8	μC	
Reverse recovery current	I _{RRM}		di/dt = 100 A/µs, V _R = 25 V		-	17	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

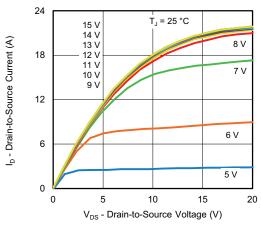


Fig. 1 - Typical Output Characteristics

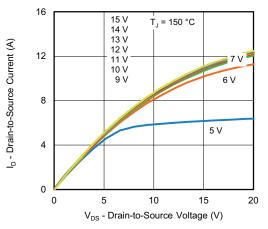


Fig. 2 - Typical Output Characteristics

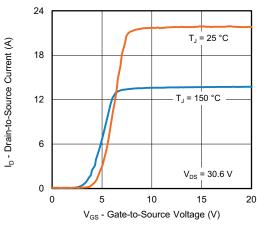


Fig. 3 - Typical Transfer Characteristics

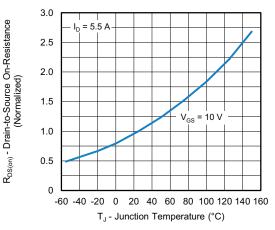


Fig. 4 - Normalized On-Resistance vs. Temperature

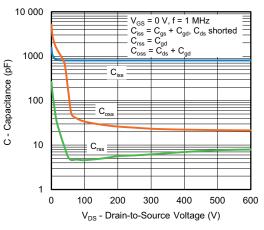


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

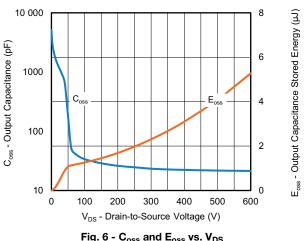


Fig. 6 - Coss and Eoss vs. VDS

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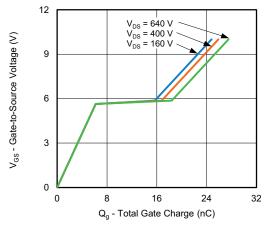


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

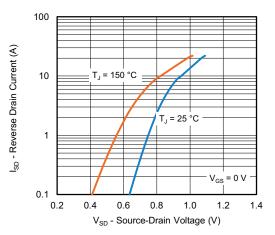


Fig. 8 - Typical Source-Drain Diode Forward Voltage

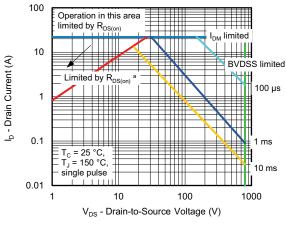


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

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Fig. 10 - Maximum Drain Current vs. Case Temperature

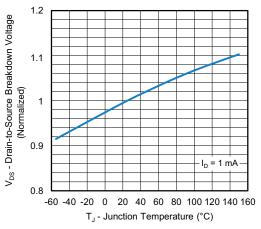


Fig. 11 - Temperature vs. Drain-to-Source Voltage



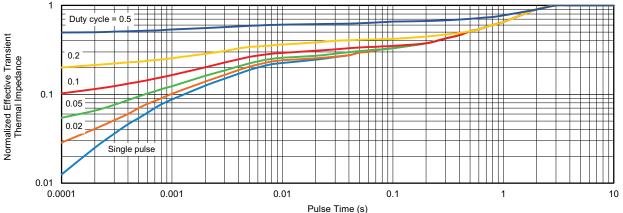


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

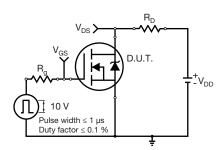


Fig. 13 - Switching Time Test Circuit

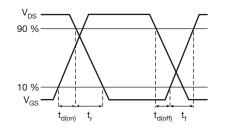


Fig. 14 - Switching Time Waveforms

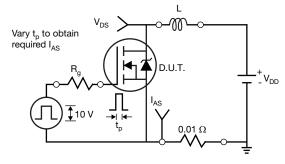
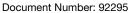


Fig. 15 - Unclamped Inductive Test Circuit

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ince, Junction-to-Case

Fig. 16 - Unclamped Inductive Waveforms

 I_{AS}

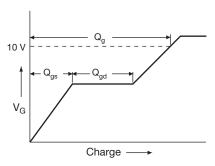
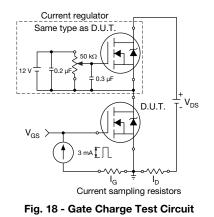


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

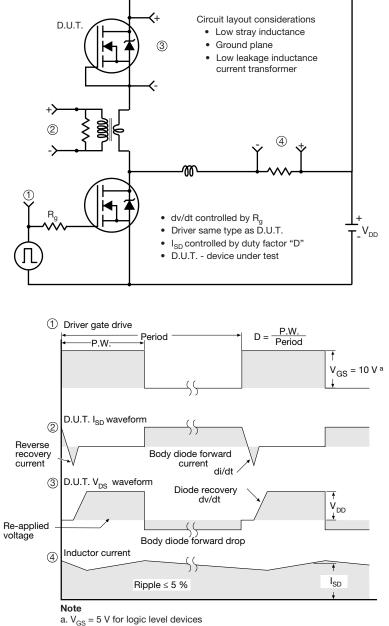


Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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